## R Series Intelligent DAQ – Data Acquisition and Control with Onboard Processing

## NI 781xR, NI 783xR, NI PXI-784xR, NI PXI-785xR NEW!

- Onboard FPGA chip, programmable with the LabVIEW FPGA Module
- User-defined triggering, timing, and decision making in hardware with 25 ns resolution
- Up to 8 analog inputs, independent sampling rates up to 750 kHz, 16-bit resolution
- Up to 8 analog outputs, independent update rates up to 1 MHz, 16-bit resolution
- Up to 160 digital lines configurable as inputs, outputs, counters, or custom logic at rates up to 40 MHz
- Direct memory access (DMA) channels for high-speed data streaming
- Implement custom control logic, inline signal processing, and digital communication protocols

#### **Operating Systems**

- Windows XP/2000
- LabVIEW Real-Time

#### **Recommended Software**

- LabVIEW
- LabVIEW FPGA Module
  - LabVIEW code compiler for FPGAs
  - Emulated debugging mode
- LabVIEW Real-Time Module

#### **Driver Software (included)**

• NI-RIO



#### **Calibration Certificate Available**

Product	Bus/Form Factor	FPGA	Analog Inputs (16-Bit)	Max Sampling Rate per Channel (kS/s)	Analog Outputs (16-Bit)	Max Update Rate per Channel (MS/s)	Digital I/O
<b>Multifunction R Series</b>							
NI 7851R	PXI	Virtex-5 LX30	8	750	8	1	96
NI 7852R	PXI	Virtex-5 LX50	8	750	8	1	96
NI 7853R	PXI	Virtex-5 LX85	8	750	8	1	96
NI 7854R	PXI	Virtex-5 LX110	8	750	8	1	96
NI 7841R	PXI	Virtex-5 LX30	8	200	8	1	96
NI 7842R	PXI	Virtex-5 LX50	8	200	8	1	96
NI 7830R	PCI, PXI	Virtex-II 1M gates	4	200	4	1	56
NI 7831R	PCI, PXI	Virtex-II 1M gates	8	200	8	1	96
NI 7833R	PCI, PXI	Virtex-II 3M gates	8	200	8	1	96
Digital R Series							
NI 7811R	PCI, PXI	Virtex-II 1M gates	_	_	_	_	160
NI 7813R	PCI, PXI	Virtex-II 3M gates	-	-	-	-	160

Table 1. R Series Selection Guide

#### **Overview**

Intelligent DAQ is multifunction data acquisition that features userdefined onboard processing as well as complete flexibility of I/O timing and triggering. You can configure all device functionality by creating NI LabVIEW block diagrams with the LabVIEW FPGA Module. Your block diagram executes in hardware, giving you direct, immediate control of all I/O signals on the PXI or PCI device. With R Series and LabVIEW FPGA, you can configure user-defined hardware for a wide variety of applications requiring precise timing and control such as:

- Data acquisition with flexible triggering and onboard processing
- High-speed analog and discrete control loops
- Pulse-width modulation (PWM) and encoder interfacing
- User-defined digital communication protocols
- Custom counters with up to 64-bit resolution
- Hardware-timed decision making at 40 MHz

## **Key Features**

Through programming in LabVIEW FPGA, you can control each of the I/O signal lines independently or synchronize a line with other channels. You can configure the digital I/O lines as custom counter/timers, PWM channels, or communication buses for user-defined protocols. All multifunction R Series devices have dedicated analog-to-digital converters/digital-to-analog converters on every analog I/O channel. This offers specialized functionality such as multirate sampling and individual channel triggering, which are beyond the capabilities of typical data acquisition hardware. You can sample every analog input channel on an R Series device simultaneously at rates up to 750 kHz, and you can program every analog output on an R Series device to update simultaneously at rates up to 1 MHz. You can also store your compiled LabVIEW FPGA application in the onboard flash memory of any R Series device and configure it for automatic loading and/or execution at power up.



#### **New Virtex-5 FPGAs**

The new NI PXI-784xR and PXI-785xR modules use new Virtex-5 field-programmable gate arrays (FPGAs) with improved optimization capabilities that provide faster code execution and increased code capacity. These Virtex-5 FPGAs feature a new six-input lookup table (LUT) architecture for substantially improved resource utilization as well as DSP48 slices that make it possible for you to implement more complex digital signal processing at faster rates. Previous-generation Virtex-II FPGAs use four-input LUTs for up to 16 combinations of digital logic values. The new Virtex-5 FPGAs use six-input LUTs for up to 64 combinations, increasing the amount of logic that you can implement per slice. In addition, the slices themselves are placed in closer proximity to each other to reduce the propagation delay of electrons and increase overall execution rates. The single-cycle timed loop structure in LabVIEW FPGA takes full advantage of six-input LUTs for substantially improved resource utilization. This means you can optimize more LabVIEW FPGA code to fit within Virtex-5 FPGAs and perform more operations per clock cycle.



Figure 1. General logic benchmarks show that Virtex-5 FPGAs offer larger sizes when compared to Virtex-II FPGAs.



Figure 2. Execution speed benchmarks show that Virtex-5 FPGAs feature faster processing capabilities when compared to Virtex-II FPGAs.

For more information on LabVIEW FPGA benchmarks for Virtex-5 FPGAs, visit ni.com/info and enter lvfpgabenchmarks.

#### **Recommended Accessories**

#### **High Performance**

**SHC68-68-RMIO** – High-performance shielded 68-conductor cable terminated with a VHDCI 68-pin male connector at one end and a 68-pin female 0.050 D-type connector at the other end that has been specifically designed for the multifunction I/O connector on R Series intelligent DAQ devices.

1 m	
2 m	

**SHC68-68-RDIO** – High-performance shielded 68-conductor cable terminated with a VHDCI 68-pin male connector at one end and a 68-pin female 0.050 D-type connector at the other end that has been specifically designed for the digital I/O connector on R Series intelligent DAQ devices.

1 m ......191667-01

**SCB-68** – Shielded I/O connector block for rugged, very low-noise signal termination for connecting to 68-pin devices. The SCB-68 also includes two general-purpose breadboard areas.

Dimensions - 19.5 by 15.2 by 4.5 cm (7.7 by 6.0 by 1.8 in.)

#### Low Cost

**SH68-C68-S** – General-purpose shielded cable that connects any type of R Series connector to 68-pin connector blocks.

0.5 m	1	186381-0R5
1 m		
2 m		

#### **Custom Cabling**

**SHC68-NT-S** – Shielded 68-conductor cable terminated with a 68-pin male VHDCI connector at one end and unterminated bare wires at the other. Use this cable, ideal for OEM applications, to create custom cabling solutions for R Series devices.

**NSC68-262650** – Shielded cable terminated with a VHDCI 68-pin male connector at one end and two 26-pin ribbon connectors and one 50-pin ribbon connector on the other; designed to connect the R Series RMIO connector to standard ribbon cable accessories.

**NSC68-5050** – Shielded cable terminated with a VHDCI 68-pin male connector at one end and two 50-pin ribbon connectors on the other; designed to connect R Series RDIO connectors to standard ribbon cable accessories.

#### **Required Software for R Series Intelligent DAQ**

- NI 781xR and 783xR devices require the LabVIEW FPGA Module 7.1 or later and NI-RIO 1.3 or later driver software.
- NI 784xR and 785xR devices require the LabVIEW FPGA Module 8.5.1 or later and NI-RIO 2.4 or later.
- NI 7853R and 7854R devices require the LabVIEW FPGA Module 8.6 or later and NI-RIO 3.0 or later.

#### Low-Cost Signal Conditioning and Channel Expansion

The NI cRIO-9151 R Series expansion chassis connects directly to any digital connector on R Series devices and houses up to four C Series I/O modules for industrial signal conditioning, I/O channel expansion, and direct sensor connectivity.

#### **Ordering Information**

#### PCI

NI PCI-7811R	
NI PCI-7813R	
NI PCI-7830R	
NI PCI-7831R	
NI PCI-7833B	

#### PXI

779362-01

#### **BUY NOW!**

For complete product specifications, pricing, and accessory information, call 800 813 3693 (U.S.) or go to **ni.com/rseries**.

## **Specifications**

#### Analog Input (NI 783xR/784xR/785xR Only)

#### **Input Characteristics**

Number of channels	
NI 7830R	4
NI 7831R/7833R/784xR/785xR	8
Input modes	DIFF, RSE, NRSE
	(software-selectable; selection
	applies to all channels)
Type of ADC	Successive approximation
Resolution	16 bits, 1 in 65,536
Conversion time	
NI 783xR/NI 784xR	4 µs
NI 785xR	1 µs
Maximum sampling rate	
NI 783xR/NI 784xR	200 kS/s (per channel)
NI 785xR	750 kS/s (per channel)
Input impedance	
Powered on	10 G ${f \Omega}$ in parallel with 100 pF
Powered off/overload	4.0 k $\Omega$ min
Input signal range	±10 V
Input bias current	
NI 783xR	±2 nA
NI 784xR/785xR	±5 nA
Input offset current	
NI 783xR	±1 nA
NI 784xR/785xR	±5 nA
Input coupling	DC
Maximum working voltage	
(signal + common mode)	Inputs should remain
	within ±12 V of ground
Overvoltage protection	
Powered on	±42 V
Powered off	±35 V
Data transfers	DMA, interrupts, programmed I/O

#### Accuracy Information – NI 783xR

Nominal Range (V	()	% of R	eading	Ab	solute / No Quar	Accuracy Noise + A Antization A		Absolute Accuracy	Relative Accurac Absolute Accuracy Resolution (µV)	
Positive Full Scale	Negative Full Scale	24 Hours	1 Year	Offset (µV)	Single Point	Averaged	Temp Drift (%/°C)	at Full Scale (±mV)	Single Point	Averaged
10.0	-10.0	0.0496	0.0507	2.542	1779	165	0.0005	7.78	2.170	217

Note: Accuracies are valid for measurements following an internal calibration. Averaged numbers assume dithering and averaging of 100 single-channel readings. Measurement accuracies are listed for operational temperatures within  $\pm 1~^\circ$ C of internal calibration temperature and  $\pm 10~^\circ$ C of external or factory-calibration temperature.

#### Accuracy Information – NI 784xR/785xR

Nominal Range (V)     % of Reading     Noise + Quantization     Absolute Accuracy     Resolution (μV)       Positive Negative Full     E     Temp Scale     Temp Scale     Temp Hours 1 Year     Temp (μV)     Temp Point     Accuracy     Resolution (μV)			Absolute Accuracy							Accuracy
Positive Negative     Temp     at Full       Full     Full     24     Offset Single     Drift     Scale       Scale     Scale     Hours 1 Year     (µV)     Point     Averaged     (±wV)     Point	Nominal Range (V)	% of Reading			Noise + Quantization		Absolute Accuracy		Resolution (µV)	
	Positive Negative Full Full Scale Scale	24 Hours	1 Year	Offset (µV)	Single Point	Averaged	Temp Drift (%/°C)	at Full Scale (±mV)	Single Point	Averaged

-10.0 0.0186 0.0228 1,591 1,029 91.6 0.0005 3.97 10.0 1,205 121 Note: Accuracies are valid for measurements following an internal calibration. Averaged numbers The second seco factory-calibration temperature.

#### **DC Transfer Characteristics**

INL	
NI 783xR	±3 LSB typ, ±6 LSB max
NI 784xR/785xR	±1 LSB typ, ±3 LSB max
DNL	
NI 783xR	-1.0 to +2.0 LSB max
NI 784xR/785xR	±0.4 LSB typ, ±0.9 LSB max
No missing codes	
NI 783xR	16 bits typ, 15 bits min
NI 784xR/785xR	16 bits guaranteed
CMRR, DC to 60 Hz	-86 dB

#### **Settling Time**

		Accuracy						
Device	Step Size	16 LSB	4 LSB	2 LSB				
	±20.0 V	7.5 µs	10.3 µs	40 µs				
NI 783XN	±2.0 V	2.7 µs	4.1 µs	5.1 µs				
	±0.2 V	1.7 µs	2.9 µs	3.6 µs				
NI 784xR/ 785xR	±20.0 V	2.1 µs	4.2 µs	8 µs				
	±2.0 V	1.3 µs	1.6 µs	1.8 µs				
	±0.2 V	0.8 µs	1.1 µs	1.2 µs				

Crosstalk..... -80 dB, DC to 100 kHz

#### **Dynamic Characteristics**

NI 783xR	
Small signal (-3 dB)	650 kHz
Large signal (1% THD)	55 kHz
NI 784xR/785xR	
Small signal (-3 dB)	1 MHz
Large signal (1% THD)	500 kHz

#### Analog Output (NI 783xR/784xR/785xR Only)

#### **Output Characteristics**

Number of channels	
NI 7830R	4
NI 7831R/7833R/784xR/785xR	8
Output type	Single-ended, voltage output
Resolution	16 bits, 1 in 65,536
Update time	1.0 µs
Maximum update rate	1 MS/s
Type of DAC	Enhanced R-2R
Data transfers	DMA, interrupts,
	programmed I/O

#### **R Series Intelligent DAQ –** Data Acquisition and Control with Onboard Processing

#### **Voltage Output**

Range	±10 V
Output coupling	DC
Output impedance	
NI 783xR	1.25 <b>Ω</b>
NI 784xR/785xR	0.5 Ω
Current drive	±2.5 mA
Protection	Short-circuit to ground
Power-on state	User configurable

#### **Accuracy Information**

Absolute Accuracy						
Nominal Range (V)		% of Reading				Absolute
Positive Full Scale	Negative Full Scale	24 Hours	1 Year	Offset (µv)	Temp Drift (%/°C)	Accuracy at Full Scale (mV)
10.0	-10.0	0.0335	0.0351	2,366	0.0005	5.88

Note: Accuracies are valid for analog output following an internal calibration. Analog output accuracies are listed for operation temperatures within ±1 °C of internal calibration temperature and ±10 °C of external or factory calibration temperature. Temperature drift applies only if ambient is greater than ±10 °C of previous external calibration.

#### **DC Transfer Characteristics**

INL	±0.5 LSB typ, ±4.0 LSB max
DNL	±0.5 LSB typ, ±1 LSB max
Monotonicity	16 bits, quaranteed

#### **Settling Time**

	Accuracy		
Step Size	16 LSB	4 LSB	2 LSB
±20.0 V	6.0 µs	6.2 µs	7.2 µs
±2.0 V	2.2 µs	2.9 µs	3.8 µs
±0.2 V	1.5 µs	2.6 µs	3.6 µs

#### **Dynamic Characteristics**

Slew rate	10 V/µs
Noise	150 µV <sub>rms</sub> , DC to 1 MHz
Glitch energy at midscale transition	±200 mV for 3 µs

#### **Digital I/O**

Number of channels NI 7811R/7813R NI 7830R NI 7831R/7833R/784xR/785xR . Digital logic levels	160 56 96 3.3 V TTL, 5 V	TTL Compatible
Level	Min (V)	Max (V)
Input low voltage (V <sub>IL</sub> )	0.0 V	0.8 V
Input high voltage (V <sub>IH</sub> )	2.0 V	5.5 V
Output low voltage (V <sub>0L</sub> ), where $I_{0UT} = -4 \text{ mA}$	-	0.4 V
Output high voltage ( $V_{OH}$ ), where $I_{OUT} = 4 \text{ mA}$	2.4 V	3.3 V
Output current Source	4.0 mA	

JUUILE	4.0 IIIA
Sink	4.0 mA
Input leakage current	±10 μΑ
Power-on state	Programmable, by line
Data transfers	DMA, interrupts,
	programmed I/O

Protection

Input	
NI 781xR/783xR	-0.5 to 7.
NI 784xR/785xR	-20.0 to 2
Output	Short-cire
	may be s
Minimum pulse width	

25 ns
12.5 ns
5 ns

#### **Reconfigurable FPGA**

#### NI 7811R/7830R/7831R

Virtex-
10,240
10,240
40
720 kb

#### NI 7813R/7833R

PGA type	Virtex-II 300
Number of flip-flops	28,672
Number of 4-input LUTs	28,672
Number of 18x18 multipliers	96
Embedded block RAM	1,728 kb

#### NI 7841R/7851R

FPGA type	Virtex-5
Number of flip-flops	19,200
Number of 6-input LUTs	19,200
Number of DSP48	
slices (25x18 multipliers)	32
Embedded block RAM	1,152 kb

#### NI 7842R/7852R

PGA type	Virtex-5 LX50
Number of flip-flops	28,800
Number of 6-input LUTs	28,800
Number of DSP48	
slices (25x18 multipliers)	48
Embedded block RAM	1,728 kb

#### NI 7853R

FPGA type	Virtex-5 LX
Number of flip-flops	51,840
Number of 6-input LUTs	51,840
Number of DSP48	
slices (25x18 multipliers)	48
Embedded block RAM	3,456 kb

#### NI 7854R

FPGA type	Virtex-5 LX110
Number of flip-flops	69,120
Number of 6-input LUTs	69,120
Number of DSP48	
slices (25x18 multipliers)	64
Embedded block RAM	4,608 kb

.0 V, single line 20.0 V, single line cuit (up to eight lines shorted at a time)

II 1000

00

LX30

(85

#### Timebases

Timebase reference sources	
NI PCI-781xR/783xR	Onboard clock only
NI PXI-78xxR	Onboard clock, phase-locked to PXI 10 MHz clock
LabVIEW FPGA derived clocks	Up to 200 MHz
Timebase accuracy, onboard clock	±100 ppm, 250 ps
·	peak-to-peak jitter
Phase-locked to PXI 10 MHz clock	
(NI PXI-78xxR only)	Adds 350 ps peak-to-peak jitter
Additional frequency-dependent peak-t	o-peak jitter
NI 781xR/783xR	
40 MHz	None
80 MHz	400 ps
120 MHz	720 ps
160 MHz	710 ps
200 MHz	700 ps
NI 784xR/785xR	
40 MHz	None
80 MHz	460 ps
120 MHz	172 ps
Calibration (NI 783xR/784xR	/785xR Only)

# Recommended warm-up time 15 minutes Calibration interval 1 year Onboard calibration reference 5.000 V (±3.5 mV) (actual value stored in flash memory) Temperature coefficient ±5 ppm/°C max Long-term stability ±20 ppm/1,000 h

**Note:** Refer to Calibration Certificates at **ni.com/calibration** to generate a calibration certificate for the NI 783xR.

#### **Bus Interface**

PXI (NI PXI-78xxR only)	Master, slave
PCI (NI PCI-781xR/783xR only)	Master, slave

#### **Physical**

Dimensions (not including connectors)	
NI PCI-781xR/783xR	17 by 11 cm (6.7 by 4.3 in.)
NI PXI-78xxR	16 by 10 cm (6.3 by 3.9 in.)
Weight	
NI PCI-781xR/783xR	112 g
NI PXI-78xxR	152 g
I/O connectors	
NI 781xR	Four 68-pin female
	high-density VHDCI type
NI 783xR/784xR/785xR	Three 68-pin female
	high-density VHDCI type

#### **Maximum Working Voltage**

Maximum working voltage refers to the signal voltage plus the<br/>common-mode voltage.Channel-to-earth±12 V, Measurement Category I<br/>±24 V, Measurement Category I

**Caution:** Do not use the NI 783xR/784xR/785xR for connection to signals in Measurement Category II, III, or IV.

#### **Power Requirement**

+5 VDC (±5%) <sup>1</sup>	
NI 781xR	9 mA (typ), 50 mA (max)
NI 7830R/7831R	330 mA (typ), 355 mA (max)
NI 7833R	364 mA (typ), 586 mA (max)
NI 7841R/7851R	125 mA (typ), 252 mA (max)
NI 7842R/7852R	136 mA (typ), 291 mA (max)
NI 7853R	460 mA typ
NI 7854R	484 mA typ
+3.3 VDC (±5%) <sup>2</sup>	
NI 7811R	650 mA (typ), 1,000 mA (max
NI 7813R	850 mA (typ), 1,350 mA (max
NI 7830R/7831R	462 mA (typ), 660 mA (max)
NI 7833R	727 mA (typ), 1,148 mA (max
NI 7841R/7851R	525 mA (typ), 1,244 mA (max
NI 7842R/7852R	604 mA (typ), 1,484 mA (max
NI 7853R	640 mA typ
NI 7854R	843 mA typ
+12 V	
NI 784xR/785xR	0.5 A
-12 V	
NI 784xR/785xR	0.25 A
+5 V terminal	
Connector 0	0.5 A max
Connector 1	0.5 A max
Connector 2	0.5 A max
All connectors	1.5 A max <sup>3</sup>
To calculate the total current sourced b	by the digital outputs, use
the following equation:	
√ j	
S current sourced on channe	li

Σ i=1

Power available at I/O connectors ..... 4.50 to 5.25 VDC at 1 A total,

250 mA per I/O connector pin

<sup>1</sup> Does not include current drawn from the +5 V line on the I/O connectors.

<sup>2</sup> Does not include current sourced by the digital outputs.

<sup>3</sup> The NI 784xR/785xR devices have a user-replaceable socketed fuse that opens when current exceeds the current specification. Refer to the R Series Intelligent DAQ User Manual, available at ni.com/manuals, for information about fuse replacement.

#### Environmental

NI 78xxR devices are intended for indoor use only.

#### **Operating Environment**

NI 781xR	0 to 55 °C (tested in accordance with IEC-60068-2-1 and IEC-60068-2-2)
NI 7830R, NI 7831R	
40 or 80 MHz timebase	0 to 55 °C (tested in accordance with IEC-60068-2-1 and IEC-60068-2-2)
NI 7833R/7841R/7842R/7851R/7852R/	7853R/7854R
40 MHz timebase	0 to 55 °C (tested in
	accordance with IEC-60068-2-1
	and IEC-60068-2-2)
80 MHz timebase	0 to 55 °C except the
	following: 0 to 45 °C when
	installed in an NI PXI-1000/B or
	NI PXI-101x (tested in
	accordance with IEC-60068-2-1
	and IEC-60068-2-2)
Relative humidity range	10 to 90%, noncondensing
	(tested in accordance with
	IEC-60068-2-56)
Altitude	2,000 m at 25 °C
	amhiont tomnoraturo

#### **Storage Environment**

Ambient temperature range	-20 to 70 °C (tested in
	accordance with IEC-60068-2-1
	and IEC-60068-2-2)
Relative humidity range	5 to 95%, noncondensing
	(tested in accordance with
	IEC-60068-2-56)

**Note:** Clean the device with a soft, nonmetallic brush. Make sure that the device is completely dry and free from contaminants before returning it to service.

#### Shock and Vibration (for NI PXI-78xxR Only)

Operational shock	30 g peak, half-sine, 11 ms pulse (tested in accordance with IEC-60068-2-27; test profile developed in accordance with MIL-PRF-28800F)
Random vibration	
Operating	5 to 500 Hz, 0.3 g <sub>rms</sub>
Nonoperating	5 to 500 Hz, 2.4 g <sub>rms</sub>
	(tested in accordance with
	IEC-60068-2-64; nonoperating test
	profile exceeds the requirements
	of MIL-PRF-28800F, Class 3)

#### **Safety and Compliance**

#### Safety

NI 78xxR devices are designed to meet the requirements of the following standards of safety for electrical equipment for measurement, control, and laboratory use:

- IEC 61010-1, EN 61010-1
- UL 61010-1, CSA 61010-1

**Note:** For UL and other safety certifications, refer to the product label or visit **ni.com/certification**, search by model number or product line, and click the appropriate link in the Certification column.

#### **Electromagnetic Compatibility**

This product meets the requirements of the following EMC standards for electrical equipment for measurement, control, and laboratory use:

- EN 61326 (IEC 61326): Class A emissions; Basic immunity
- EN 55011 (CISPR 11): Group 1, Class A emissions
- AS/NZS CISPR 11: Group 1, Class A emissions
- FCC 47 CFR Part 15B: Class A emissions
- ICES-001: Class A emissions

#### **CE Compliance**

This product meets the essential requirements of applicable European Directives, as amended for CE marking, as follows:

- 2006/95/EC; Low-Voltage Directive (safety)
- 2004/108/EC; Electromagnetic Compatibility Directive (EMC)

**Note:** Refer to the Declaration of Conformity (DoC) for this product for any additional regulatory compliance information. To obtain the DoC for this product, visit **ni.com/certification**, search by model number or product line, and click the appropriate link in the Certification column.

#### **Environmental Management**

National Instruments is committed to designing and manufacturing products in an environmentally responsible manner. NI recognizes that eliminating certain hazardous substances from our products is beneficial not only to the environment but also to NI customers.

For additional environmental information, refer to the NI and the Environment Web page at **ni.com/environment**. This page contains the environmental regulations and directives with which NI complies, as well as other environmental information not included in this document.

#### Waste Electrical and Electronic Equipment (WEEE)

**EU Customers:** At the end of their life cycle, all products must be sent to a WEEE recycling center. For more information about WEEE recycling centers and National Instruments WEEE initiatives, visit **ni.com/environment/weee.htm**.

#### 电子信息产品污染控制管理办法(中国 RoHS)

● ● 中国客户 National Instruments 符合中国电子信息产品中限制使用某些有害物质指 令 (RoHS)。关于 National Instruments 中国 ROHS 合规性信息,请登录 ni.com/environment/rohs\_china。(For information about China RoHS compliance, go to ni.com/environment/rohs\_china.)

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integrators. Services range from start-up assistance to turnkey system integration. Visit ni.com/alliance.

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We also offer service programs that provide automatic upgrades to your application development environment and higher levels of technical support. Visit ni.com/ssp.

#### **Hardware Services**

#### NI Factory Installation Services

NI Factory Installation Services (FIS) is the fastest and easiest way to use your PXI or PXI/SCXI combination systems right out of the box. Trained NI technicians install the software and hardware and configure the system to your specifications. NI extends the standard warranty by one year on hardware components (controllers, chassis, modules) purchased with FIS. To use FIS, simply configure your system online with ni.com/pxiadvisor.

#### **Calibration Services**

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